1934357-1 ✓ ACTIVE

Z-PACK | Z-PACK TinMan

TE Internal #: 1934357-1

High Speed Backplane Connectors, 90 Position, Mating Alignment, Guide Slot Mating Alignment Type, 9 Row, 10 Column, PCB Mount Header, Z-PACK TinMan

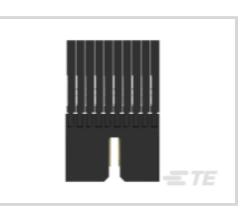
View on TE.com >



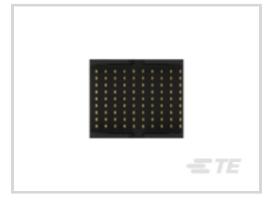
Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors











Connector System: Board-to-Board

Number of Positions: 90

Row-to-Row Spacing: 1.4 mm [.055 in]

Mating Alignment: With

Mating Alignment Type: Guide Slot

Features

Product Type Features

Backplane Module Type	Center
Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Pairs per Column	3
Number of Pairs	30
Stackable	No
Number of Signal Positions	60
Backplane Architecture	Co-Planar
Number of Positions	90

9

Number of Rows



PCB Mount Orientation Right An ectrical Characteristics Impedance 100 Ω Operating Voltage 250 VAC gnal Characteristics Differential Impedance 100 Ω Number of Differential Pairs per Column 3 Data Rate 10 Gb/s pody Features Shield Material Phospho Primary Product Color Black ontact Features Contact Mating Area Length 6 mm[.23 PCB Contact Termination Area Plating Material Thickness .5 μm[20 Contact Mating Area Plating Material Finish Matte Contact Shape & Form Rectange PCB Contact Termination Area Plating Material Tin Contact Base Material Phospho Contact Base Material Tin Contact Current Rating (Max) .5 A	r Bronze 36 in]
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PCB Contact Termination Area Plating Material Tin Contact Base Material Phospho	
Contact Base Material Phospho	ular
Contact Current Rating (Max) .5 A	r Bronze
ermination Features	
Termination Post & Tail Length 2.2 mm[.	087 in]
Termination Method to Printed Circuit Board Through	Hole - Press-Fit
lechanical Attachment	
Guide Hardware Without	
Mating Retention Without	
PCB Mount Alignment Without	
PCB Mount Retention With	
PCB Mount Retention Type Action/C	
Mating Alignment With	Compliant Tail



Mating Alignment Type	Guide Slot
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	2
End Wall Location	Open
Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	1.9 mm[.075 in]
Dimensions	
Connector Length	19.15 mm
Connector Height	16 mm
Connector Width	28.8 mm
PCB Thickness (Recommended)	1.57 mm[.062 in]
PCB Hole Diameter	.47 mm
Row-to-Row Spacing	1.4 mm[.055 in]
Usage Conditions	
Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	UL
Approved Standards	UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube, Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235)



	Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

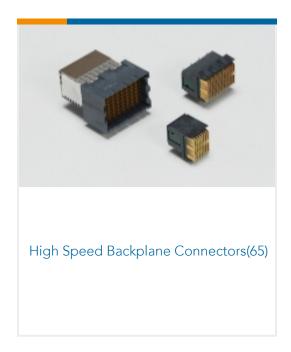
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Z-PACK TinMan



Customers Also Bought

















Documents

Product Drawings

Tinman R/A Header Assy 3x10 Open

English

CAD Files

Customer View Model

ENG_CVM_CVM_1934357-1_B.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1934357-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1934357-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector

English

Product Specifications

Application Specification

English